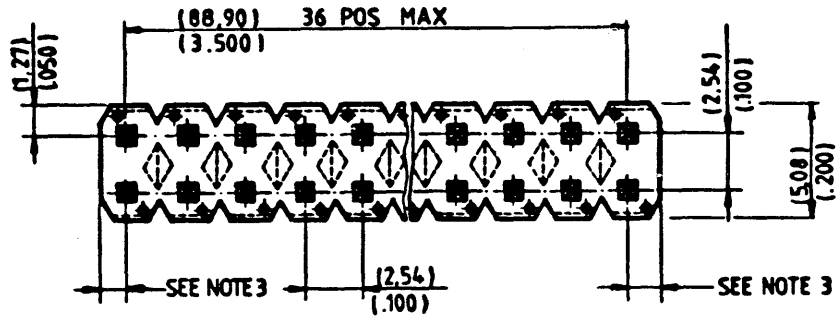
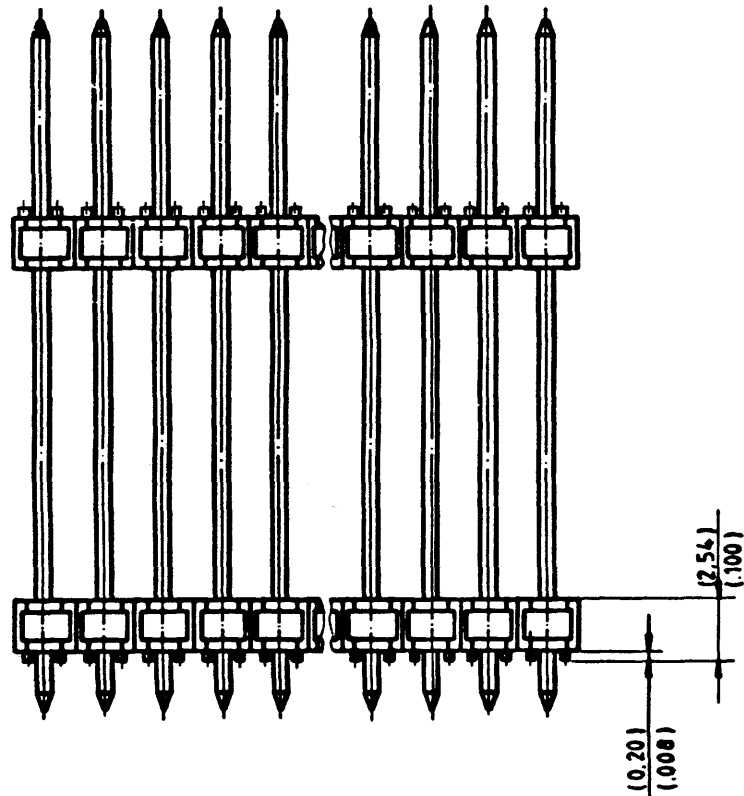


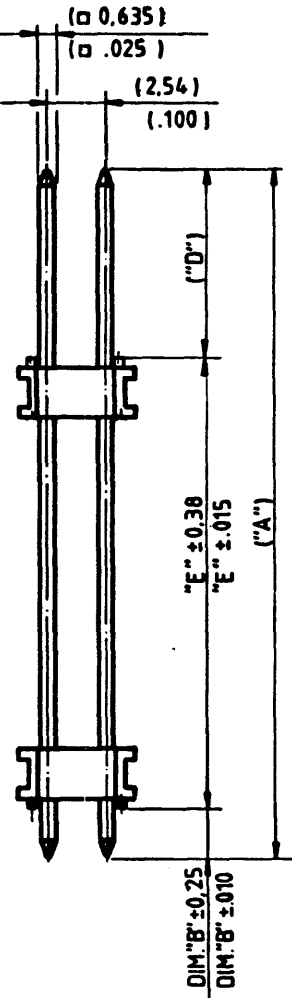
PRODUCT NR	DIM."A"	DIM."B"	DIM."D"	DIM."E"
77390 - X01 - YY	(16,56) (.652)	2,95 .116	(2,95) (.116)	10,66 .420

SEE NOTE 4



PLATING CODE	MIN. PLATING THICKNESS
1	0,76 μ m Au OVER 1,27 μ m Ni
0	PLAIN

PLATING CODE	MIN. PLATING THICKNESS
3	3,81 μ m SnPb over 1,27 μ m Ni
2	1,27 μ m Au OVER 1,27 μ m Ni



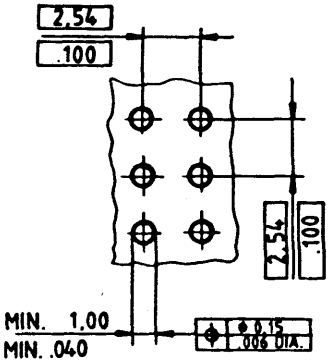
PLATING CODE	MIN. PLATING THICKNESS
9	0,20 μ m Au OVER 1,27 μ m Ni
8	0,30 μ m Au OVER 1,27 μ m Ni
6	0,76 μ m Pd-Ni/Au over 1,27 μ m Ni
5	0,30 μ m Pd-Ni/Au over 1,27 μ m Ni

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DIMENSIONS DO NOT SCALE

NOTES



RECOMMENDED HOLE PATTERN

- NOTES:
- MATERIAL PIN: 3/4 H PHOSPHOR BRONZE.
 - MATERIAL BODY: POLYAMID, COLOUR BLACK.
 - DIM. 1,27^{+0,03}_{-0,13} (0,50^{+0,001}_{-0,05}) FOR MOLDED SIDE(S); IF SIDE(S) ARE BROKEN DIM. 1,27 $\pm$ 0,25 (0,50 $\pm$ 0,10).
 - TERMINAL PUSH-OUT FORCE : 22,6 N.
 - YY IN THE PRODUCT NUMBER INDICATES THE NUMBER OF POSITIONS WANTED. (E.G. 76 745 - XXX - 08 INDICATES 2 x 4 POSITION HEADER)

CUSTOMER COPY FOR REFERENCE ONLY

NO SHARP EDGES ALLOWED ☒ FOR CHAMFER MARK		DATE 28 JAN 85		APP. E. MEYER	DATE 30 MAY 85
MATERIAL SEE NOTES		DR. NMIRA		RELEASED 2598	
HEAT TREAT		CHK. 0.1.1		DATE 0.1.1	
FINISH SEE TABLE		BERG ELECTRONICS DIVISION		s-HERTOGENBOSCH - HOLLAND	
LAYOUT		POSNO. C	SIZE	DWG NO. 77390	REV.
SCALE 5:1		TITLE PARALLEL MOUNT HEADER, DOUBLE ROW			

77390
SHEET 213-1 OF 1